

Applicant : Auch et al.  
Serial No. : 09/989,362  
Filed : November 20, 2001  
Page : 2 of 9

Attorney's Docket No.: 12406-060US1/P2002,0611 US  
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Amendments to the Claims:

This listing of claims replaces all prior versions and listings of claims in the application:

Listing of Claims:

1. (Currently Amended) An organic light emitting device comprising:  
a substrate with a device region defined thereon;  
an active component on a surface of the substrate in the device region, wherein  
the active component includes an organic light emitting diode;  
a cap mounted on the substrate to form a package, the cap ~~creates~~ creating a  
cavity over the device region to seal the active component; and  
spacer particles fixed to the active component, the spacer particles preventing the  
cap from contacting the active component.
2. (Previously Presented) The device of claim 1 wherein the device region  
comprises one or more cells.
3. (Original) The device of claim 2 wherein the spacer particles comprise a non-  
conductive material.
4. (Currently Amended) The device of claim 3 wherein the spacer particles are  
coated with ~~a layer of an~~ an adhesive layer.
5. (Original) The device of claim 4 wherein the adhesive layer comprises thermal  
curable material.
6. (Original) The device of claim 4 wherein the adhesive layer comprises ultraviolet  
curable material.

Applicant : Auch et al.  
Serial No. : 09/989,362  
Filed : November 20, 2001  
Page : 3 of 9

Attorney's Docket No.: 12406-060US1/P2002,0611 US  
E

7. (Original) The device of claim 4 wherein the adhesive layer comprises hot melt material.

8. (Currently Amended) ~~The A device of claim 1 comprising:~~  
a substrate with a device region defined thereon;  
an active component on a surface of the substrate in the device region;  
a cap mounted on the substrate to form a package, the cap creating a cavity over  
the device region to seal the active component; and  
spacer particles fixed to the active component, the spacer particles preventing the  
cap from contacting the active component, wherein the spacer particles are coated with a layer  
of an adhesive layer.

9. (Original) The device of claim 8 wherein the adhesive layer comprises thermal curable material.

10. (Original) The device of claim 8 wherein the adhesive layer comprises ultraviolet curable material.

11. (Original) The device of claim 8 wherein the adhesive layer comprises hot melt material.

12. (Original) The device of claims 1, 2, 3, 4, 5, 6, 7, 8, 9, 10 or 11 wherein the spacer particles are randomly distributed in the device region, occupying both active and non-active regions.

13. (Original) The device of claims 1, 2, 3, 4, 5, 6, 7, 8, 9, 10 or 11 wherein the spacer particles are randomly distributed in the device region, selectively occupying non-active regions.

Applicant : Auch et al.  
Serial No. : 09/989,362  
Filed : November 20, 2001  
Page : 4 of 9

Attorney's Docket No.: 12406-060US1/P2002,0611 US  
E

14. (Previously Presented) The device of claim 12 wherein the spacer particles comprise a spherical or non-spherical shape or a combination thereof.

15. (Original) The device of claim 14 wherein the spacer particles comprises a mean diameter to maintain a height of the cavity between the cap and substrate.

16. (Original) The device of claim 15 wherein the spacer particles comprise a density to maintain the cavity.

17-23. (Canceled)

24. (Previously Presented) The device of claim 13 wherein the spacer particles comprise a spherical shape or non-spherical shape or a combination thereof.

25. (Original) The device of claim 24 wherein the spacer particles comprises a mean diameter to maintain a height of the cavity between the cap and substrate.

26. (Original) The device of claim 25 wherein the spacer particles comprise a density to maintain the cavity.

27-55. (Canceled)

56. (Currently Amended) A device comprising:  
a substrate with a device region;  
a sealing dam surrounding the device region;  
a cap supported by the sealing dam;  
spacer particles fixed to a surface of the device region to support the cap;  
a sealing region abutting an outer surface of the sealing dam;  
an adhesive located in the sealing region, the adhesive hermetically sealing the device region, ~~wherein the sealing dam reduces a sealing width of the device.~~

Applicant : Auch et al.  
Serial No. : 09/987,362  
Filed : November 20, 2001  
Page : 5 of 9

Attorney's Docket No.: 12406-060US1/P2002,0611 US  
E

57. (Previously Presented) The device of claim 56 wherein the device region comprises one or more OLED cells.

58. (Previously Presented) The device of claim 57 wherein the spacer particles comprise a non-conductive material.

59. (Previously Presented) The device of claim 58 wherein the spacer particles are coated with a layer of adhesive.

60. (Previously Presented) The device of claim 56 wherein the spacer particles are coated with a layer of adhesive.

61. (Previously Presented) The device of claims 56, 57, 58, 59 or 60 wherein the spacer particles are randomly distributed in the device region, occupying both active and non-active regions.

62. (Previously Presented) The device of claims 56, 57, 58, 59, or 60 wherein the spacer particles are randomly distributed in the device region, selectively occupying non-active regions.

63. (Previously Presented) The device of claim 61 wherein the spacer particles comprise a spherical or non-spherical shape or a combination thereof.

64. (Previously Presented) The device of claim 63 wherein the spacer particles comprise a mean diameter to maintain a height of the cavity between the cap and substrate.

65. (Previously Presented) The device of claim 64 wherein the spacer particles comprise a density to maintain the cavity.

Applicant : Auch et al.  
Serial No. : 09/98<sup>1</sup>,362  
Filed : November 20, 2001  
Page : 6 of 9

Attorney's Docket No.: 12406-060US1/P2002,0611 US  
B

66. (Previously Presented) The device of claim 62 wherein the spacer particles comprise a spherical or non-spherical shape or a combination thereof.

67. (Previously Presented) The device of claim 66 wherein the spacer particles comprise a mean diameter to maintain a height of the cavity between the cap and substrate.

68. (Previously Presented) The device of claim 67 wherein the spacer particles comprise a density to maintain the cavity.